

Preface

The Organizing Committee warmly welcomes all participants of the 4th International Conference on Composite Material, Polymer Science and Engineering (CMPSE2020), which was held on December 06-07, 2020 (virtual), South Korea.

The aim of CMPSE2020 was to bring together experts from the academia and industry to present and discuss their research results and development in the areas of composite materials and polymer science, superalloys, ceramics, and chemical technologies. It provided opportunities for delegates to exchange new ideas and application experiences, and to establish collaborations.

The collected papers are focused on research in the areas of polymers and composites, superalloys, nanomaterials and functional materials, materials for electronic engineering and ceramics environmental and chemical engineering.

We would like to thank acknowledge the technical comments from the reviewers and thank all of the authors for their contributions to this proceeding book.

Finally, we wish all the authors and attendees of CMPSE2020 productive and happy experience with this webinar conference.

With our warmest regards,

Editor

Katsuyuki Kida, Professor, the University of Toyama, Japan

December 10, 2020

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